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Project Size.		1.69 inch				
Model No.		P169H00	2-CTP			
Samples No.						
Product type.	240xRGBx280					
Froduct type.	MCU mode					
Signature by cus	tomer					
Prepared		Checked	Approved			

Email: polcd@polcd.com

Mobile: 86-136 0019 7172

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#### 1.0 GENERAL DESCRIPTION

#### 1.1 Introduction

Display model P169H002-CTP is a (TM)Transmissive type color active matrix thin Film transistor(TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. This model is composed of a TFT LCD panel, a driving circuit, a back light system. The resolution of a 1.69" contains 240RGB\*280dots and can display up to 262k colors.

Item	Specification	Unit
Screen Size	1.69 inch	Diagonal
Number of Pixel	240RGB(H)x280(V)	Pixels
Display area	27.97(H)x32.63(V)	mm
Pixel pitch	0.11655(H)x0.11655(V)	mm
Outline Dimension	33.13x41.13x3.61	mm
Pixel arrangement	RGB Vertical Stripe	
Display mode	Normally Black	
Viewing Direction(eye)	ALL	
Gray inversion direction		
Display Color	262K	
Luminance(cd/m²)	350	nit
Contrast Ratio	800:1	
Surface treatment		
Interface	4-line SPI	
Back-light	LED Side-light type	
Drive IC	ST7789V	
Operation Temperature	-20~70	$^{\circ}$ C
Storage Temperature	-30~80	$^{\circ}$ C
Weight		g

#### 1.2 Features

n 4-line SPI parallel interface.

#### 1.3 Applications

- n MPOS Device.
- n Personal Navigation Device.
- n Other devices which require high quality displays.

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#### 2.0 INPUT INTERFACE PIN ASSIGNMENT

FPC connector is used for electronics interface.

I/O: I: input, O: output, P: power

PinNo.	Symbol	Function		
1	GND	Ground		
2	LEDK	LED back light(Cathode)		
3	LEDA	LED back light(Anode)		
4	VCC	Power Supply. 2.8V		
5-6	GND	Ground		
7	D/C	Display data/command selection pin in parallel		
8	CS	Chip select input pin		
9	SCL	Serial interface clock		
10	SDA	SPI interface input/output pin		
11	RESET	External reset input.		
12	GND	Ground		
13	TP_SCL	Touch screen clock signal		
14	TP_SDA	Touch data input/output bidirectional pins		
15	TP_TRST	Touch screen reset signal		
16	TP_TINT	Touch screen interrupt signa		
17	VDD_0.3V	Touch screen power supply		
18	GND	Ground		

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#### 3.0 ABSOLUTE MAXIMUM RATINGS

#### 3.1 Electrical Absolute Rating

#### 3.1.1 TFT LCD Module

Item	Symbol	Min	Max	Unit	Note
Digital supply voltage	VDDI	-0.3	+4.6	V	GND=0
Analog supply voltage	VCI	-0.3	+4.6	V	GND=0
Logic Signal Input Level	VIN	-0.3	VDDI+0.5	V	GND=0

3.1.2 Back-Light Unit

Item	Symbol	Min	Max	Unit	Note
LED current	I <sub>BL</sub>	-	60	mA	
LED voltage	$V_{BL}$	2.8	3.2	V	-

#### 3.2 Environment Absolute Rating

ltem	Symbol	Min	Max	Unit	Note
Operating temperature	TOPR	-20	70	°C	-
Storage temperature	TSTG	-30	80	°C	-

Note:

Permanent damage may occur to the LCD module if beyond this specification.

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#### **4.0 OPTICAL CHARACTERISTICS**

#### 4.1 Optical specification

Item		Symbol	Condition	Min	Туре	Max	Unit	Note
White luminance (Center)	)	Lv	0.0		350	-	cd/m <sup>2</sup>	(4)(5)(7)
Response time		Tr+Tf	Θ=0 Normal		35	45	ms	(3)
Contrast ratio		CR	Viewing	800	1000			(2)(4)
Color Chromaticity	white	Wx	Angle I <sub>BL</sub> =60mA		0.323			(6)
(CIE1931)	wille	Wy	IBL—COIII		0.347			(6)
	Hor	ΘL		70	80			
Viewing Angle	1101	ΘR	CR≥10	70	80			(1)
Viewing Angle	Ver	ΘU	CR210	70	80			(1)
	vei	ΘD		70	80			
Brightness unifo	rmity	Avg	Θ=0	80	90		%	(5)
Color Gamut		NTSC	Θ=0		70		%	(6)
Optima View Dir	ima View Direction Free					(1)		

#### **4.2 Measuring Condition**

n Measuring surrounding: dark room

n LED current IL: 60mA

n Ambient temperature: 25±2℃

n 15min. warm-up time

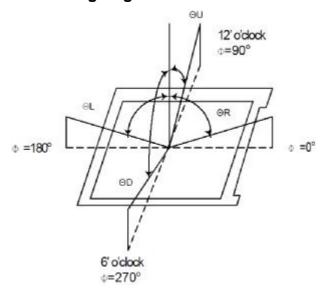
#### **4.3 Measuring Equipment**

**n** BM-7

n Measuring spot size: 30 ~ 31 mm

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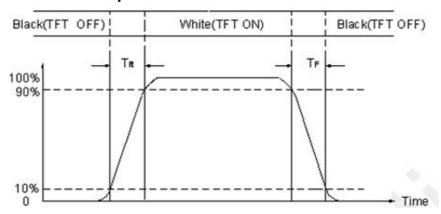
Note (1) Definition of Viewing Angle



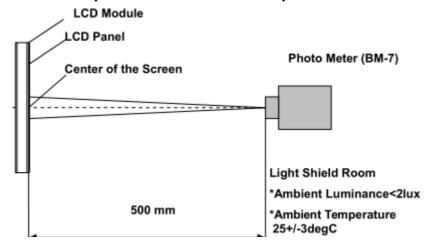
Note (2) Definition of Contrast Ratio(CR):

Measured at the center point of panel

Note (3) Definition of Response Time: Sum of TR and TF



Note (4) Definition of optical measurement setup



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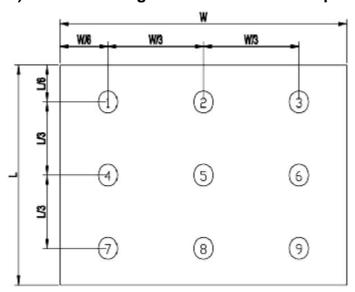
#### Note (5) Definition of brightness uniformity

The luminance uniformity is calculated by using following formula.

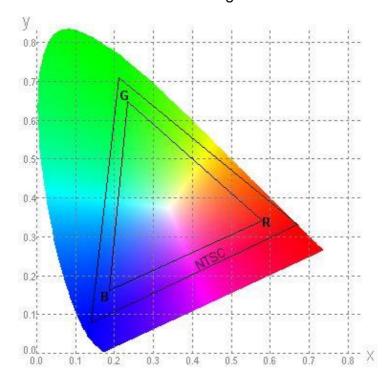
 $\triangle$ Bp = Bp (Min.) / Bp (Max.)×100 (%)

**Bp (Max.) = Maximum brightness in 9 measured spots** 

Bp (Min.) = Minimum brightness in 9 measured spots .



Note (6) Definition of Color of CIE1931 Coordinate and NTSC Ratio. Color gamut:

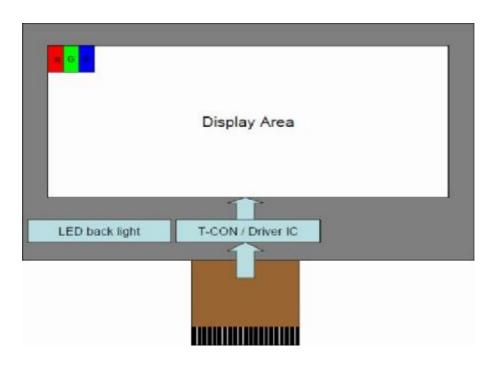


Note (7) Measured the luminance of white state at center point.

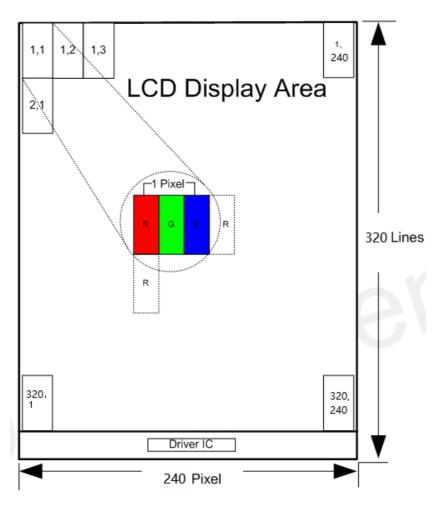
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#### **5.0 BLOCK DIAGRAM**

#### **5.1 TFT LCD Module**



#### 5.2 Pixel Format



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#### **6.0 ELECTRICAL CHARACTERISTICS**

#### 6.1 TFT LCD Module

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Analog supply voltage	VDD	2.4	2.8	3.3	V	
Digital supply voltage	VDDI	1.65	1.8	3.3		
Input signal Valtage	VIH	0.7VDDI	-	VDDI	V	
Input signal Voltage	VIL	GND	-	0.3VDDI	V	

#### 6.2 Back-Light Unit

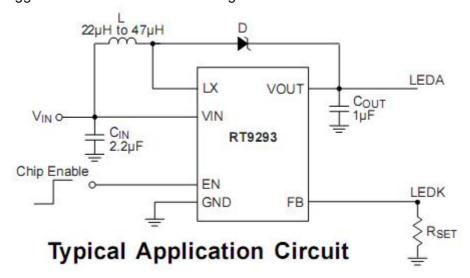
The backlight system is an edge-lighting type with 3 LED Dies. The characteristics of the LED are shown in the following tables.

Item	Symbol	Min	Тур	Max	Unit	Note
LED current	IL	-	45	60	mA	(2)
LED voltage	VL	-	3.2	1	V	
Operating LED life time	Hr	-	4500	-	Hour	(1)(2)

Note (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition:  $Ta=25\pm3$  °C, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note (2) The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and IL=80mA. The LED lifetime could be decreased if operating IL is larger than 100mA. The constant current driving method is suggested.

Note (3) Suggested schematic of LED backlight driver



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#### **6.3 Interface Characteristics**

8080 Series Serial interface Characteristics: 4-line

#### 7.4.3 Serial Interface Characteristics (4-line serial):

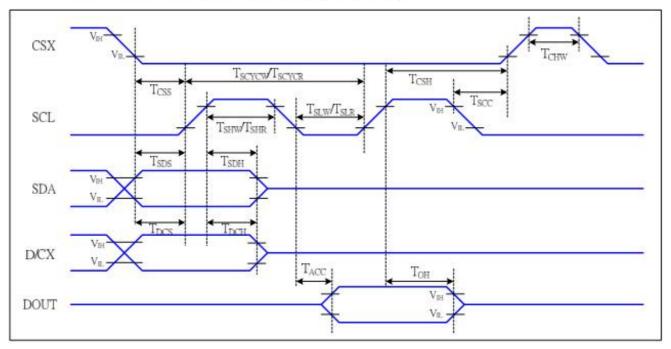


Figure 5 4-line serial Interface Timing Characteristics

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 to 70 ℃

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
	T <sub>CSS</sub>	Chip select setup time (write)	15		ns	
	T <sub>CSH</sub>	Chip select hold time (write)	15		ns	
CSX	T <sub>CSS</sub>	Chip select setup time (read)	60	9.0	ns	
	T <sub>SCC</sub>	Chip select hold time (read)	65		ns	
	T <sub>CHW</sub>	Chip select "H" pulse width	40		ns	
	T <sub>SCYCW</sub>	Serial clock cycle (Write)	66		ns	-write command & data
	T <sub>SHW</sub>	SCL "H" pulse width (Write)	15		ns	
SCL	T <sub>SLW</sub>	SCL "L" pulse width (Write)	15		ns	ram
SUL	T <sub>SCYCR</sub>	Serial clock cycle (Read)	150		ns	road command 0 data
	T <sub>SHR</sub>	SCL "H" pulse width (Read)	60		ns	-read command & data
	T <sub>SLR</sub>	SCL "L" pulse width (Read)	60		ns	ram
D/CX	T <sub>DCS</sub>	D/CX setup time	10		ns	
DIGA	T <sub>DCH</sub>	D/CX hold time	10		ns	
SDA	T <sub>SDS</sub>	Data setup time	10		ns	
(DIN)	T <sub>SDH</sub>	Data hold time	10		ns	
DOUT	T <sub>ACC</sub>	Access time	10	50	ns	For maximum CL=30pF
DOOT	Тон	Output disable time	15	50	ns	For minimum CL=8pF

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### 7.0 Reliability conditions

NO	Item	Conditions	Notes
1	High Temperature Storage	Ta=80℃±2℃, 72hrs	
2	Low Temperature Storage	Ta=-30℃±2℃, 72hrs	
3	High Temperature Operation	Ta=70°C±2°C, 72hrs(Operation state)	
4	Low Temperature Operation	Ta=-20°C ±2°C, 72hrs(Operation state)	
5	High Temperature and High Humidity (Storage)	Ta=+60°C, 90%RH, 72hrs	
6	Thermal Cycling Test (non operation)	-20°C(30min) → +70°C(30min), 10cycles	
7	Electro static Discharge	Human Body Mode $100pF\pm10\%/1500~\Omega\pm1\%$ Air $\pm8kV$ / contact $\pm6kV$ Consecutive 10times/ Each discharge $\frac{R}{V=0}$ CLASS STRESS LEVELS (LASS 11 2999-3999V CLASS 11 4998-15988 V	
8	Vibration test(with carton)	Total fixed amplitude:15mm Vibration Frequency:10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	
9	Drop (with carton)	Height: 60cm 1 corner, 3 edges, 6 surfaces	

Note: There is no display function NG issue occurred, all the cosmetic specification is judged before the reliability stress.

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#### 8.0 Precautions

#### 8.1 Operation

Burn-in sometimes happens when the same character was displayed at along time. Therefore, to prevent Burn-in, it is recommended to set up a Screen-saver function.

#### 8.2 Safety

The liquid crystal in the LCD is poisonous, DO NOT put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

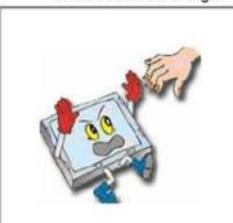
#### 8.3 Handling

<ul> <li>a. The LCD module shall be installed flat, without twisting or bending.</li> <li>b. COF or FPC has narrow pattern width, so easily become open circuit by external force. DO NOT apply pressure to COF or FPC especially in bending area.</li> </ul>
c. To avoid damage in appearance or malfunction, DO NOT subject the module to mechanical shock or to excessive force on its surface.
d. The polarizer attached to the display is very easy to damage, handle it with care to avoid scratching.
e. To avoid contamination on the display surface, DO NOT touch the display surface with bare hands.  f. Provide a space so that the LCD module does not come into contact with other components.

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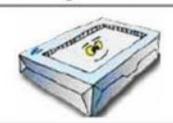
#### 8.4 Static Electricity

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge.



- The LCD module shall be installed flat, without twisting or bending. Ground soldering iron tips, tools and testers when they operate.
- Ground your body when handling the products.
- DO NOT apply voltage to the input terminal without applying power supply.
- DO NOT apply voltage that exceeds the absolute maximum rating.
- e. Store the products in an anti-electrostatic container.
- Peel off protect tape, attached to polarizer, slowly to minimize ESD damage.

#### 8.5 Storage



Store the products in a dark place at  $+5 \sim +25$  degree C, low humidity (50%RH or less).

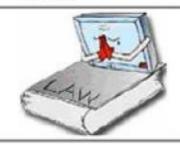
DO NOT store the products in an atmosphere containing organic solvents or corrosive gases.

#### 8.6 Cleaning



- DO NOT wipe the polarizer with dry cloth, as it might cause scratch.
- Wipe the polarizer with a soft cloth soaked with petroleum IPA, other chemical might damage.

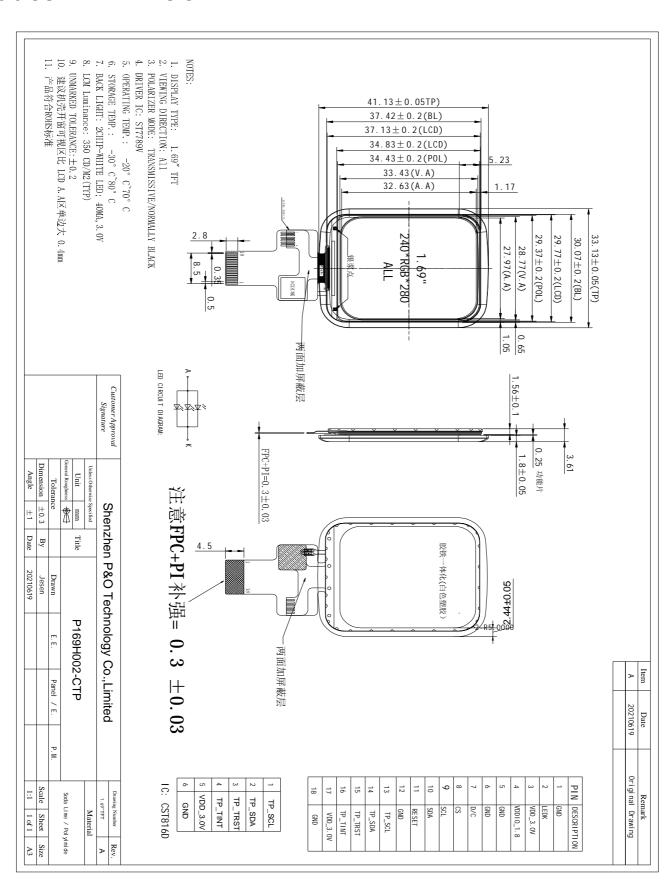
#### 8.7 Waste



When dispose of LCD module, manage it at the production waste according to the relevant laws and regulations.

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#### 9.0 OUTINE DIMENSION



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#### **1 0.0 LOT MARK**

#### **10.1 Location of Lot Mark**

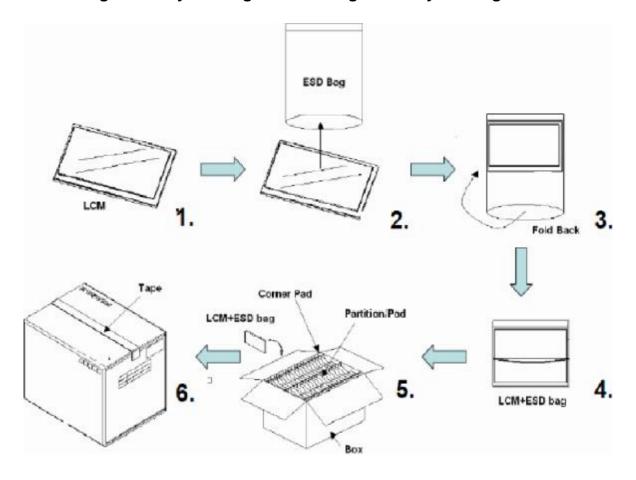
- (1) Location: The label is attached to the backside of the LCD module.
- (2) Detail of the Mark: as attached below.
- (3) This is subject to change without prior notice.

#### 11.0 PACKAGE SPECIFICATION

#### 11.1 Packing form

LCM Model	LCM Qty. in the box	Inner Box Size ( mm )	Notice
	TDB	TDB	

#### 11.2 Packing assembly drawings11.2 Packing assembly drawings



Items	Material	Notice
Box	Corrugated Paper Board	AB Flute
Partition/Pad	Corrugated Paper Board	A/B Flute
Corner Pad	Corrugated Paper Board	AB Flute
ESD bag	PE	

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#### 12.1 Guarantee

APEX warrants the quality of our products for *1 year* (from the date of delivery). If there are functional defects found during the period of warranty, the defective products would be replaced on a one-to-one backapex would not be responsible for any direct /indirect liabilities consequential to any parties.

All the products should be stored or used as specified conditions described in these sheets. If module productions are not stored or used as specified conditions, herein, it will be void the *1 year* warranty(guarantee).

#### 12.2 Visual inspection criterion in cosmetic

#### (1) Glass defect

	Glass defect					
NO	Defect	Criteria	Remark			
1	Dimension(Minor)	By engineering diagram	↑ ↑			
2	Cracks(Major)	Extensive crack 【Reject】				

(2) LCM appearance defect

NO	Defect	Criteria		Remark
		Spec	Permissible Qty	1.ψ=(L+W)/2, L: Length, W: Width
		ψ≦0.10mm	Disregard	2. Disregard if out of A.A.
1	Round type(Minor)	$0.10$ mm $<$ $\psi \le 0.20$ mm	3	
		0.20mm<ψ	0	W V
		Spec	Permissible	1. L: Length, W: Width
			Qty	2. Disregard if out of A.A.
2	Line type(Minor)	W≦0.03mm	Disregard	
		L≦3.0mm and	2	$\leftarrow$ ${\smile}$
		0.03mm <w≦0.05mm< td=""><td></td><td></td></w≦0.05mm<>		
		L≦3.0mm and	1	
		0.05mm <w≦0.10mm< td=""><td></td><td>W</td></w≦0.10mm<>		W
		W>0.10mm orL>3.0mm	0	100,00
		Spec.	Permissible	1.ψ=(L+W)/2 , L: Length,
			Qty	W: Width
3		ψ≦0.20mm	Disregard	2.Disregard if out of A.A.
	Polarizer	0.20mm<ψ≦ 0.30mm	2	
	dent(Minor)	0.30mm<ψ≦ 0.50mm	1	

(3) FPC

NO	Defect	Criteria	Remark

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1	Copper peeling(Minor)	Copper peeling 【Reject】	
		FPC golden finger broken, dead fold, indentation	
		makes FPC surface broken 【Reject】	
2		Tin plating layer(or gold plating) scratch, but not hurt	
	Golden finger	circuit 【Accept】	
		Except circuit, other position scratch but not expose	
		metal wire 【Accept】	
		FPC PI layer delamination 【Reject】	
		Material and color are inconsistent with sample, FPC	
		burrs 【Reject】	
3	Pin	FPC Pin deformation but not affect function. 【Accept】	
		FPC Pin area is dirty 【Reject】	
		Other than FPC Pin area is dirty but not affect function	
		【Accept】	
		Golden finger edge has burrs,foreign material [Reject]	
		Golden finger oxidation (dark), uneven electroplating,	
		pinhole, foreign material 【Reject】	
		Golden finger soldering pad crack exceeds 1/3 length	
4	Golden finger	of soldering pad, and soldering pad crack exceed 2	
	Oolderi iiriger	Pins 【Reject】	
		Golden finger tin plating(or gold plating)scratch, but	
		not hurt circuit 【Accept】	
		Other than golden finger area scratch but not expose	
		metal circuit 【Accept】	
5	FPC Silk printing	Ghosting, incomplete silk printing, wrong printing	
		【Reject】	
6	FPC Circuit line width	Line width deviation exceed 1/3 line width 【Reject】	

#### (4) Black tape

NO	Defect	Criteria	Remark
1	Shift(Minor)	IC exposed 【Reject】	
2	No black tape(Minor)	No black tape 【Reject】	

#### (5) Silicon

NO	Defect	Criteria	Remark
1	Amount of silicon (Minor)	ITO exposed 【Reject】	

#### 12.3 Visual inspection criterion in electrical display

П	NO	Defect	Criteria	Remark

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1	No display (Major)	No	ot allowed		
2	Missing line (Major)	No	ot allowed		
3	Darker or lighter Line (Major)	No	ot allowed		
4	Weak line(Major)	By limited sample			
5	Bright / Dark point (Minor)	Spec. Permissible Bright 1 point		e Qty	1:1sub-pixel: 1R or 1G or1B 2:Point defect area ≥ 1/2 sub pixel.
		-	2		
6	Round type (Minor)	Spec		Permissible Qty	1.ψ=(L+W)/2, L: Length, W: Width
		ψ≦0.10mm		Disregard	2. Disregard if out of A.A.
		0.10mm<ψ≦ 0.20mm		3	
		0.20mm<ψ		0	w v
	Line type (Minor)	Spec.		Permissible	1. L: Length, W: Width
7				Qty	2. Disregard if out of A.A.
		W≦0.03mm		Disregard	ī
		L≦3.0mm and		2	
		$0.03\text{mm} < W \le 0.05\text{mm}$ $L \le 3.0\text{mm and}$ $0.05\text{mm} < W \le 0.10\text{mm}$ $W > 0.10\text{mm} \qquad \text{or}$ $L > 3.0\text{mm}$ $W > 0.10\text{mm} \qquad \text{or}$ $L > 3.0\text{mm}$			
				1	<b>7</b>
					W
				0	
	NA (NA:				
8	Mura (Minor)	By 5% ND filter invisible			

#### 9.2.4. Others

- 1. Issues that are not defined in this document shall be discussed and agreed with both parties. (Customer and supplier)
- 2. Unless otherwise agreed upon in writing, the criteria shall be applied to both parties. (Customer and supplier)